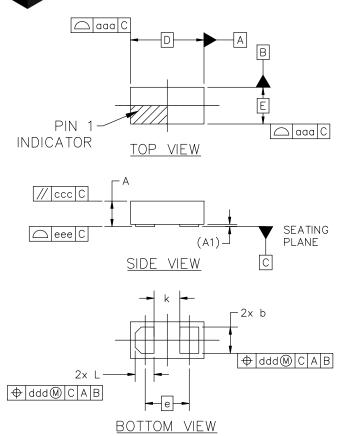


X4DFN2, 0.60x0.30x0.20, 0.36PCASE 152AX ISSUE K

DATE 20 JUN 2025



NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.

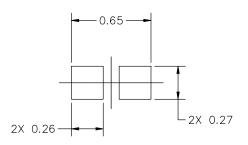
GENERIC MARKING DIAGRAM*



X = Specific Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present. Some products may not follow the Generic Marking.

MILLIMETERS				
DIM	MIN	NOM	MAX	
А	0.175	0.200	0.225	
A1	0.018 REF			
b	0.205	0.215	0.225	
D	0.600 BSC			
E	0.300 BSC			
е	0.360 BSC			
k	0.180			
L	0.145	0.155	0.165	
TOLERANCE FORM AND POSITION				
aaa	0.025			
ссс	0.020			
ddd	0.050			
eee	0.010			



RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb—Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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